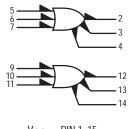
Dual 3-Input/3-Output OR Gate

The MC10210 is designed to drive up to six transmission lines simul—taneously. The multiple outputs of this device also allow the wire "OR"—ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines with minimum propagation delay from a single point makes the MC10210 particularly useful in clock distribution applications where minimum clock skew is desired.

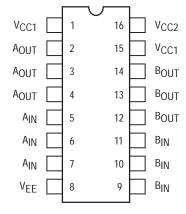
- $P_D = 160 \text{ mW typ/pkg (No Loads)}$
- $t_{pd} = 1.5$ ns typ (All Output Loaded)
- t_{Γ} , $t_{f} = 1.5$ ns typ (20%–80%)

LOGIC DIAGRAM



 V_{CC1} = PIN 1, 15 V_{CC2} = PIN 16 V_{EE} = PIN 8

DIP PIN ASSIGNMENT



Pin assignment is for Dual–in–Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

1



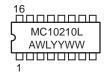
ON Semiconductor

http://onsemi.com

MARKING DIAGRAMS

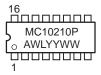


CDIP-16 L SUFFIX CASE 620





PDIP-16 P SUFFIX CASE 648





PLCC-20 FN SUFFIX CASE 775



A = Assembly Location

WL = Wafer Lot YY = Year WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping		
MC10210L	CDIP-16	25 Units / Rail		
MC10210P	PDIP-16	25 Units / Rail		
MC10210FN	PLCC-20	46 Units / Rail		

ELECTRICAL CHARACTERISTICS

				Test Limits							
Characteristic			Pin Under Test	−30°C		+25°C		+85°C		1	
		Symbol		Min	Max	Min	Тур	Max	Min	Max	Unit
Power Supply	Drain Current	ΙE	8		42			38		42	mAdc
Input Current		l _{inH}	5, 6, 7		650			410		410	μAdc
		l _{inL}	5, 6, 7	0.5		0.5			0.3		μAdc
Output Voltage	e Logic 1	VOH	2 3 4	-1.060 -1.060 -1.060	-0.890 -0.890 -0.890	-0.960 -0.960 -0.960		-0.810 -0.810 -0.810	-0.890 -0.890 -0.890	-0.700 -0.700 -0.700	Vdc
Output Voltage	e Logic 0	VOL	2 3 4	-1.890 -1.890 -1.890	-1.675 -1.675 -1.675	-1.850 -1.850 -1.850		-1.650 -1.650 -1.650	-1.825 -1.825 -1.825	-1.615 -1.615 -1.615	Vdc
Threshold Volt	tage Logic 1	VOHA	2 3 4	-1.080 -1.080 -1.080		-0.980 -0.980 -0.980			-0.910 -0.910 -0.910		Vdc
Threshold Volt	tage Logic 0	VOLA	2 3 4		-1.655 -1.655 -1.655			-1.630 -1.630 -1.630		-1.595 -1.595 -1.595	Vdc
Switching Time	es (50Ω Load)										ns
Propagation D	Pelay	t5+2+ t5-2- t5+3+ t5-3- t5+4+ t5-4-	2 2 3 3 4 4	1.0 1.0 1.0 1.0 1.0	2.6 2.6 2.6 2.6 2.6 2.6	1.0 1.0 1.0 1.0 1.0	1.5 1.5 1.5 1.5 1.5 1.5	2.5 2.5 2.5 2.5 2.5 2.5	1.0 1.0 1.0 1.0 1.0	2.8 2.8 2.8 2.8 2.8 2.8	
Rise Time	(20 to 80%)	t ₂₊ t ₃₊ t ₄₊	2 3 4	1.0 1.0 1.0	2.6 2.6 2.6	1.0 1.0 1.0	1.5 1.5 1.5	2.5 2.5 2.5	1.0 1.0 1.0	2.8 2.8 2.8	
Fall Time	(20 to 80%)	t ₂₋ t ₃₋ t ₄₋	2 3 4	1.0 1.0 1.0	2.6 2.6 2.6	1.0 1.0 1.0	1.5 1.5 1.5	2.5 2.5 2.5	1.0 1.0 1.0	2.8 2.8 2.8	

ELECTRICAL CHARACTERISTICS (continued)

			-		TEST VO	LTAGE VALU	JES (Volts)		
		@ Test Te	mperature	VIHmax	V _{ILmin}	VIHAmin	VILAmax	VEE	
			-30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
			Pin	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
Characteristic		Symbol	Under Test	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	VEE	(VCC) Gnd
Power Supply Drain 0	Current	ΙE	8					8	1, 15, 16
Input Current		l _{inH}	5, 6, 7	*				8	1, 15, 16
		l _{inL}	5, 6, 7		*			8	1, 15, 16
Output Voltage	Logic 1	VOH	2 3 4	5 6 7				8 8 8	1, 15, 16 1, 15, 16 1, 15, 16
Output Voltage	Logic 0	VOL	2 3 4					8 8 8	1, 15, 16 1, 15, 16 1, 15, 16
Threshold Voltage	Logic 1	VOHA	2 3 4			5 6 7		8 8 8	1, 15, 16 1, 15, 16 1, 15, 16
Threshold Voltage	Logic 0	VOLA	2 3 4				5 6 7	8 8 8	1, 15, 16 1, 15, 16 1, 15, 16
Switching Times	(50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay		t5+2+ t5-2- t5+3+ t5-3- t5+4+ t5-4-	2 2 3 3 4 4			5 5 5 5 5	2 2 3 3 4 4	8 8 8 8 8	1, 15, 16 1, 15, 16 1, 15, 16 1, 15, 16 1, 15, 16 1, 15, 16
Rise Time	(20 to 80%)	t ₂₊ t ₃₊ t ₄₊	2 3 4			5 5 5	2 3 4	8 8 8	1, 15, 16 1, 15, 16 1, 15, 16
Fall Time	(20 to 80%)	t ₂ _ t ₃ _ t ₄ _	2 3 4			5 5 5	2 3 4	8 8 8	1, 15, 16 1, 15, 16 1, 15, 16

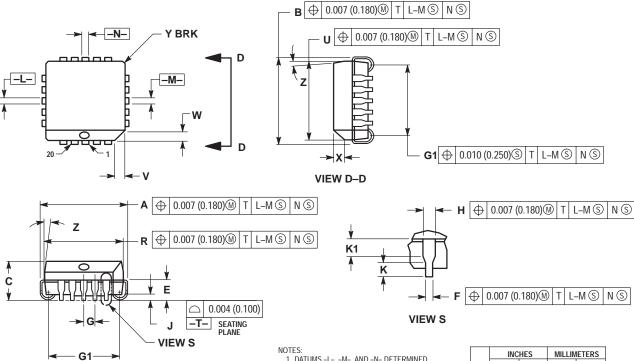
^{*} Individually test each input using the pin connections shown.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

PACKAGE DIMENSIONS

PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 ISSUE C



⊕ 0.010 (0.250)⑤ T L-M ⑤ N ⑤

- DATUMS -L-, -M-, AND -N- DETERMINED
 WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

 2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD
- FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
 4. DIMENSIONING AND TOLERANCING PER ANSI

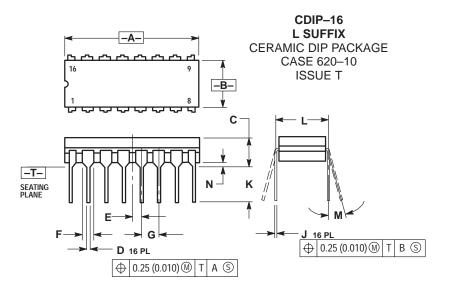
- 714.5M, 1982.

 5. CONTROLLING DIMENSION: INCH.

 6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO .0.12 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.385	0.395	9.78	10.03	
В	0.385	0.395	9.78	10.03	
С	0.165	0.180	4.20	4.57	
Ε	0.090	0.110	2.29	2.79	
F	0.013	0.019	0.33	0.48	
G	0.050	BSC	1.27	BSC	
Н	0.026	0.032	0.66	0.81	
J	0.020		0.51		
K	0.025		0.64		
R	0.350	0.356	8.89	9.04	
U	0.350	0.356	8.89	9.04	
V	0.042	0.048	1.07	1.21	
W	0.042	0.048	1.07	1.21	
Χ	0.042	0.056	1.07	1.42	
Υ		0.020		0.50	
Z	2°	10°	2 °	10 °	
G1	0.310	0.330	7.88	8.38	
K1	0.040		1.02		

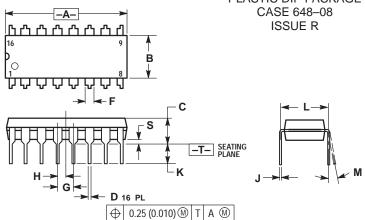
PACKAGE DIMENSIONS



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MIN MAX		MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
E	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300	BSC	7.62	BSC	
M	0°	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	

PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIMETERS		
DIM	MIN	MIN MAX		MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

Notes

Notes

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